2SJ528(L),2SJ528(S)

Silicon P Channel MOS FET
High Speed Power Switching

HITACHI

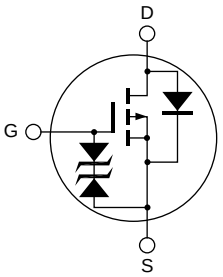
ADE-208-641A (Z)
2nd. Edition
Jun 1998

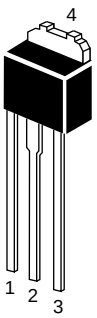
Features

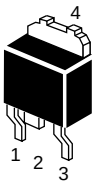
- Low on-resistance $R_{DS(on)}$ = 0.17 Ω typ.
- 4 V gete drive devices
- High speed switching

Outline

DPAK–2







1. Gate
2. Drain
3. Source
4. Drain

Hitachi semiconductor

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	–60	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	–7	A
Drain peak current	$I_{D(pulse)}$ Note1	–28	A
Body-drain diode reverse drain current	I_{DR}	–7	A
Avalenche current	I_{AP} Note3	–7	A
Avalenche energy	E_{AR} Note3	4.2	mJ
Channel dissipation	Pch Note2	20	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	–55 to +150	°C

Note: 1. PW ≤ 10µs, duty cycle ≤ 1 %
2. Value at Tc = 25°C
3. Value at Tch = 25°C, Rg ≥ 50 Ω

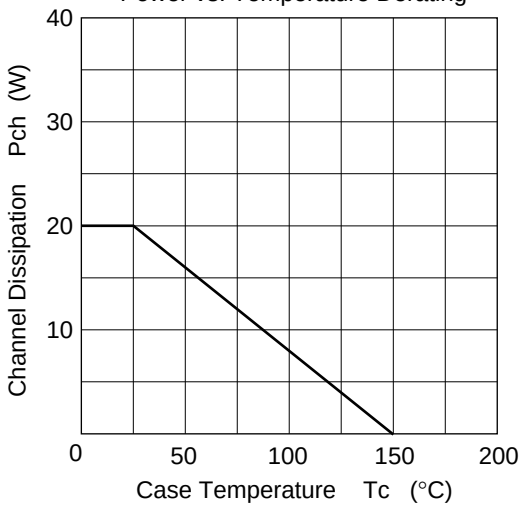
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	–60	—	—	V	I_D = –10mA, V_{GS} = 0
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	I_G = ±100µA, V_{DS} = 0
Zero gate voltege drain current	I_{DSS}	—	—	–10	µA	V_{DS} = –60 V, V_{GS} = 0
Gate to source leak current	I_{GSS}	—	—	±10	µA	V_{GS} = ±16V, V_{DS} = 0
Gate to source cutoff voltage	$V_{GS(off)}$	–1.0	—	–2.0	V	I_D = –1mA, V_{DS} = –10V
Static drain to source on state	$R_{DS(on)}$	—	0.17	0.22	Ω	I_D = –4A, V_{GS} = –10V Note4
resistance	$R_{DS(on)}$	—	0.24	0.37	Ω	I_D = –4A, V_{GS} = –4V Note4
Forward transfer admittance	$\|y_{fs}\|$	3.0	5.0	—	S	I_D = –4A, V_{DS} = –10V Note4
Input capacitance	Ciss	—	400	—	pF	V_{DS} = –10V
Output capacitance	Coss	—	220	—	pF	V_{GS} = 0
Reverse transfer capacitance	Crss	—	75	—	pF	f = 1MHz
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	V_{GS} = –10V, I_D = –4A
Rise time	t_r	—	40	—	ns	R_L = 7.5Ω
Turn-off delay time	$t_{d(off)}$	—	75	—	ns	
Fall time	t_f	—	65	—	ns	
Body–drain diode forward voltage	V_{DF}	—	–1.1	—	V	I_F = –7A, V_{GS} = 0
Body–drain diode reverse recovery time	t_{rr}	—	65	—	ns	I_F = –7A, V_{GS} = 0 diF/ dt = 50A/µs

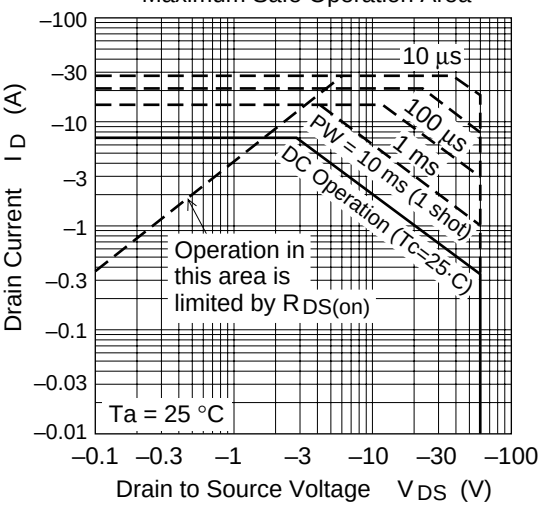
Note: 4. Pulse test

Main Characteristics

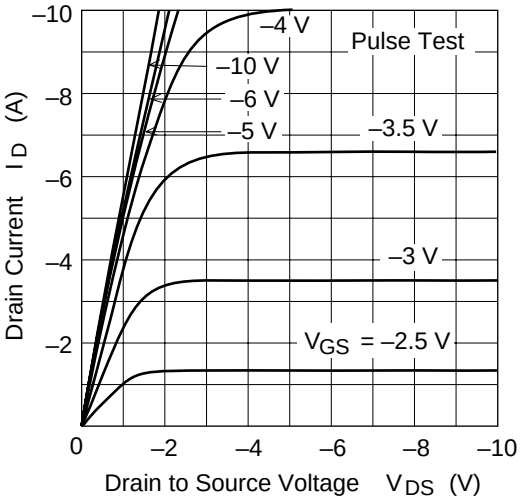
Power vs. Temperature Derating



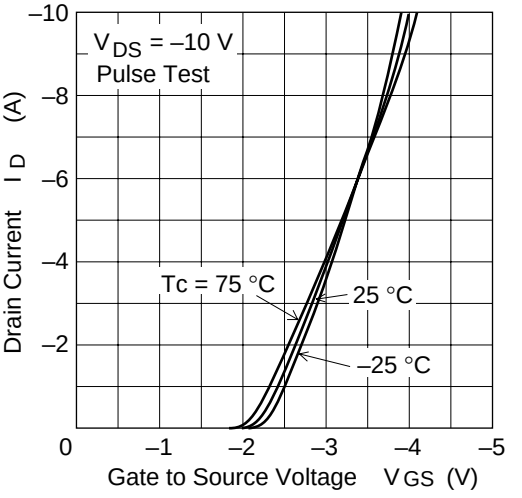
Maximum Safe Operation Area



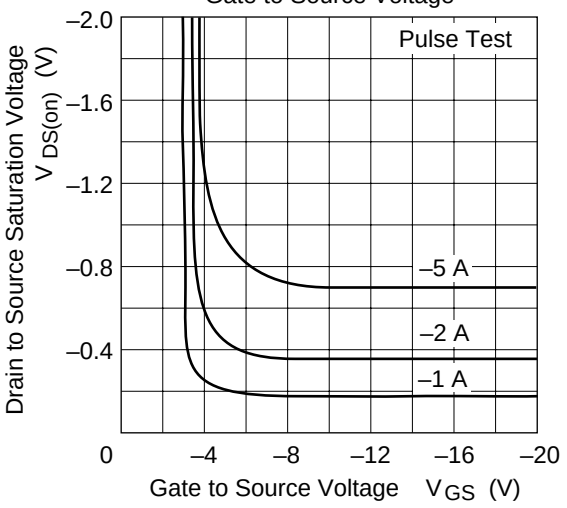
Typical Output Characteristics



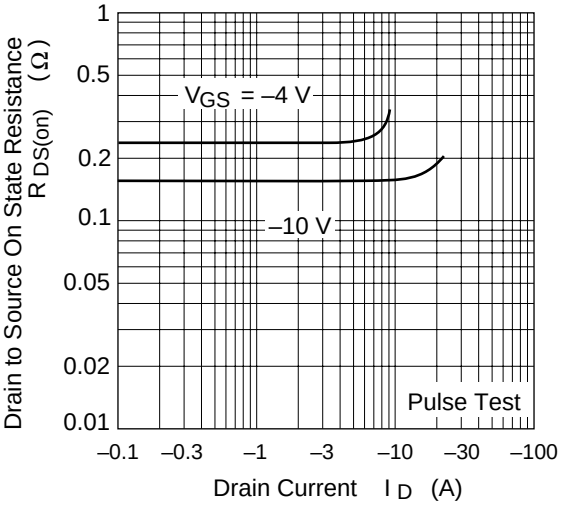
Typical Transfer Characteristics



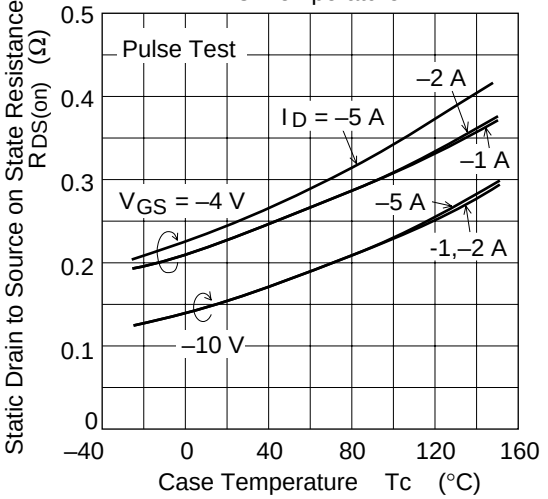
Drain to Source Saturation Voltage vs. Gate to Source Voltage



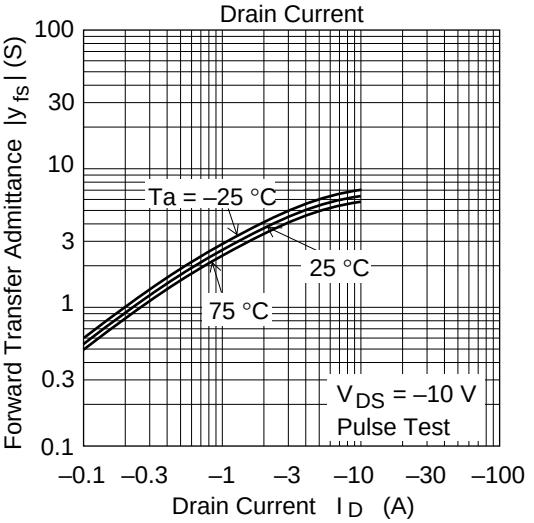
Static Drain to Source on State Resistance vs. Drain Current



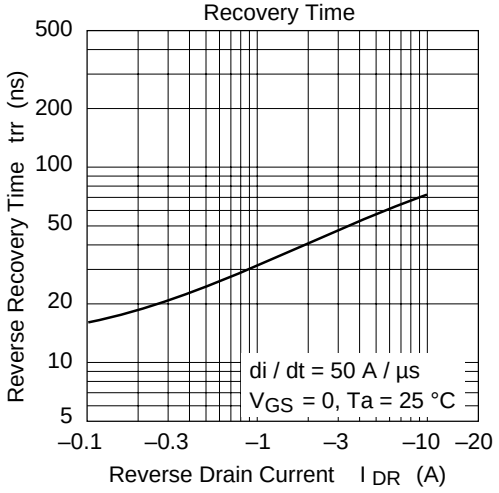
Static Drain to Source on State Resistance vs. Temperature



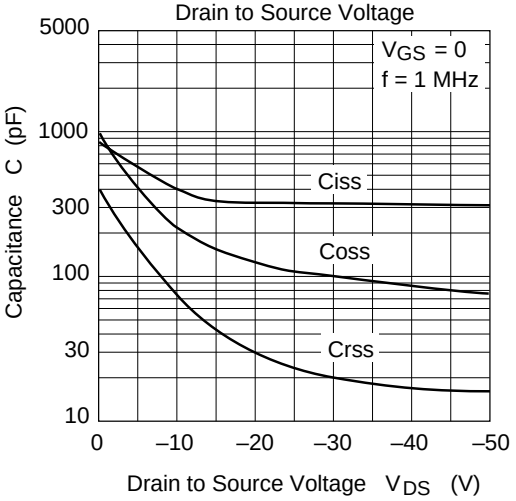
Forward Transfer Admittance vs. Drain Current



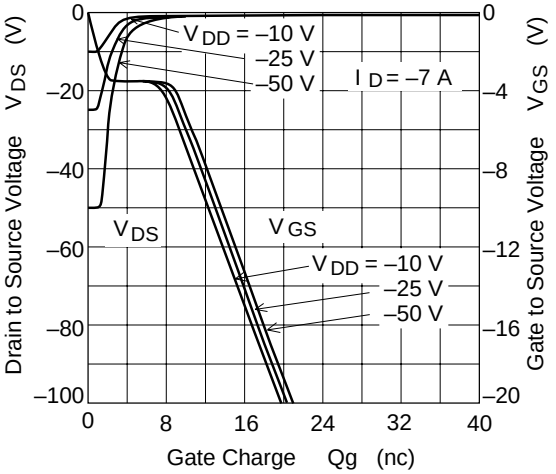
Body–Drain Diode Reverse Recovery Time



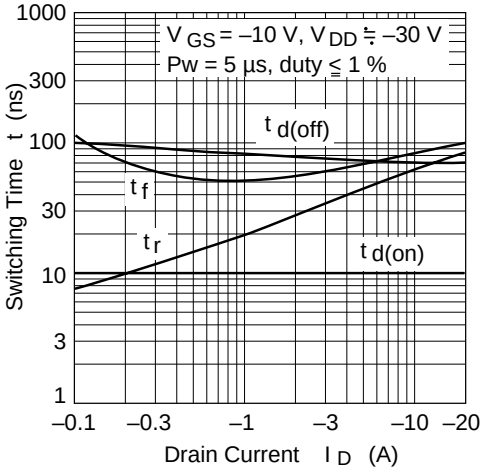
Typical Capacitance vs. Drain to Source Voltage



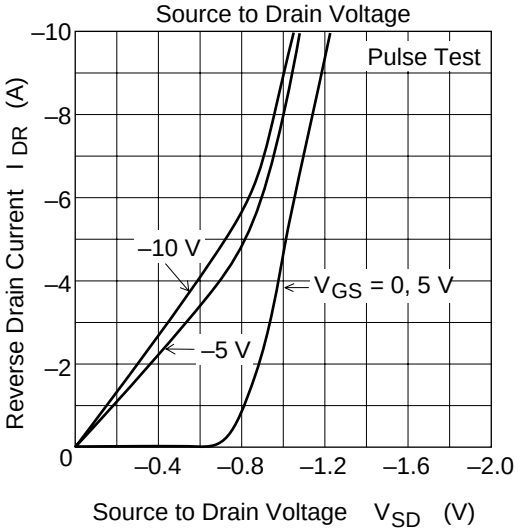
Dynamic Input Characteristics



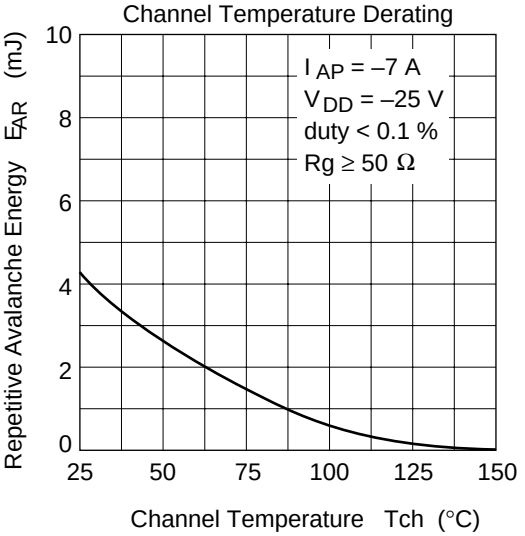
Switching Characteristics



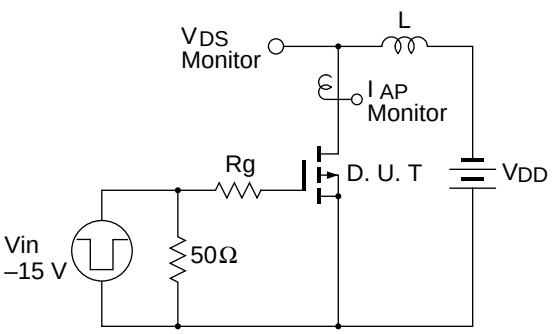
Reverse Drain Current vs.
Source to Drain Voltage



Maximum Avalanche Energy vs.
Channel Temperature Derating

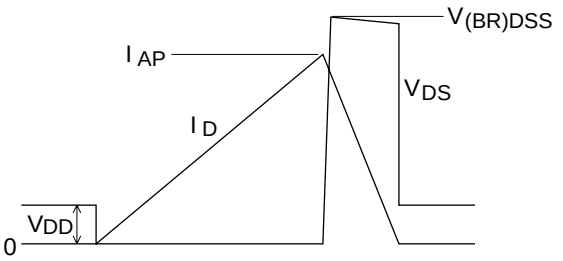


Avalanche Test Circuit

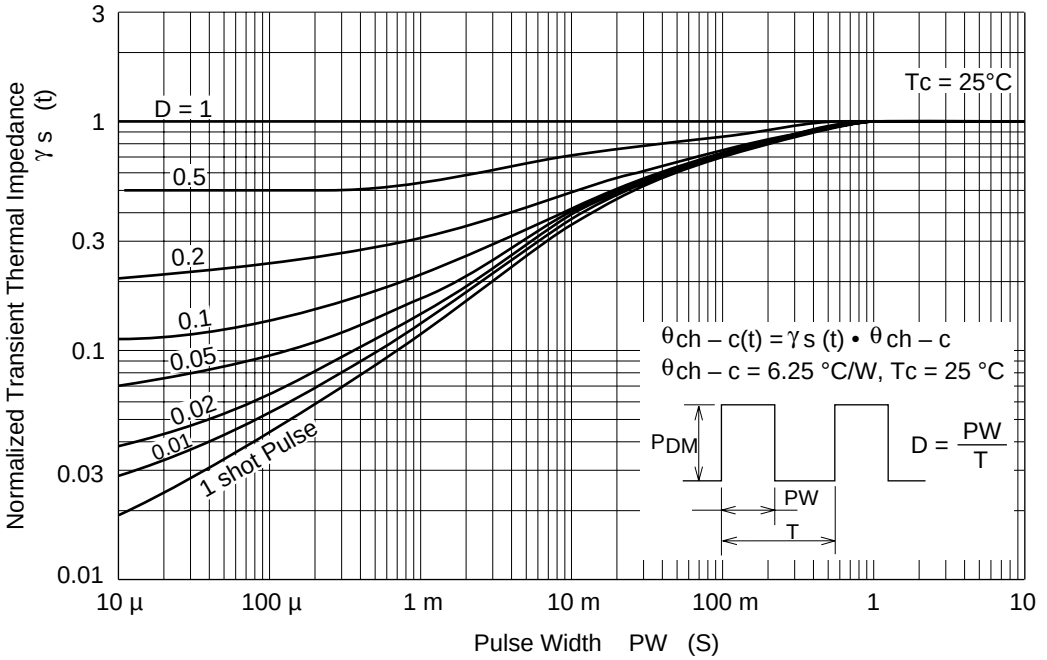


Avalanche Waveform

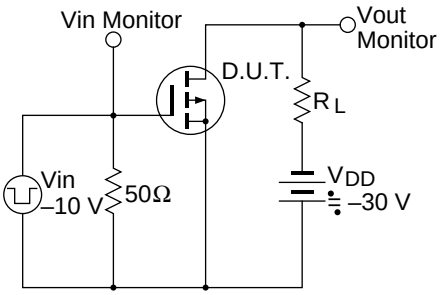
$$E_{AR} = \frac{1}{2} \bullet L \bullet {I_{AP}}^2 \bullet \frac{V_{DSS}}{V_{DSS} - V_{DD}}$$



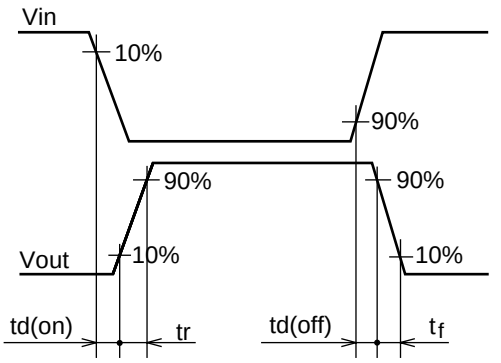
Normalized Transient Thermal Impedance vs. Pulse Width



Switching Time Test Circuit

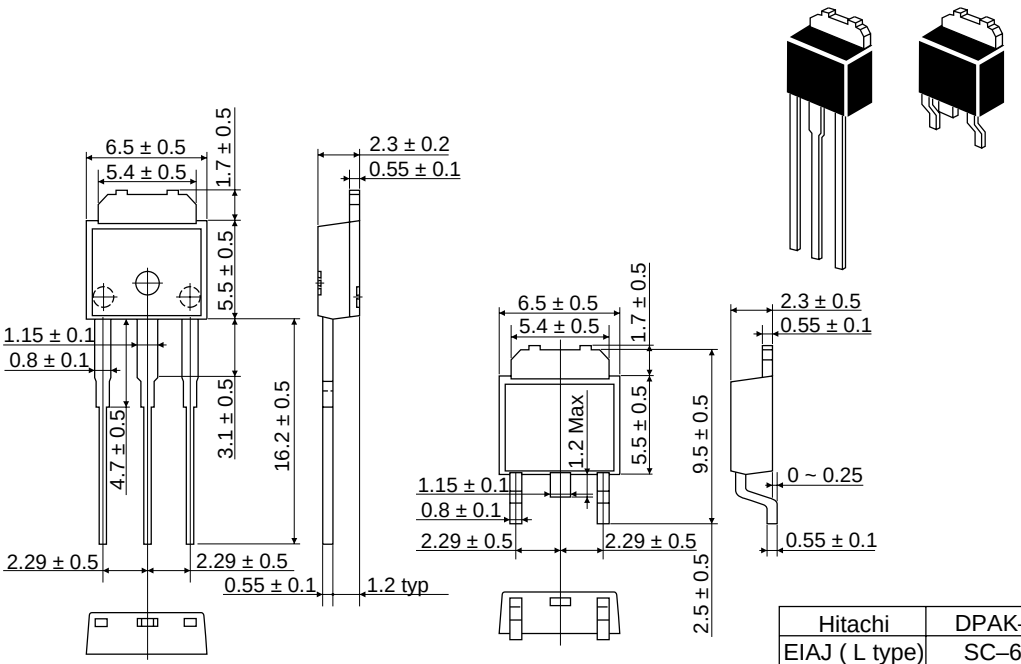


Waveform



Package Dimensions

Unit: mm



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Hitachi, Ltd.
Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose,CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
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